

New Product

Vishay Siliconix

P-Channel 2.5-V (G-S) MOSFET

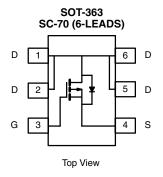
PRODUCT SUMMARY					
V _{DS} (V)	$r_{DS(on)}\left(\Omega\right)$	I _D (A)			
- 25	0.180 at V _{GS} = - 4.5 V	± 1.5			
	0.200 at $V_{GS} = -3.6 \text{ V}$	± 1.4			
	0.265 at V _{GS} = - 2.5 V	± 1.2			

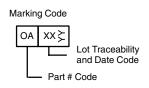
FEATURES

• TrenchFET® Power MOSFET



RoHS³





Ordering Information: Si1403DL-T1

Si1403DL-T1-E3 (Lead (Pb)-free)

ABSOLUTE MAXIMUM RATINGS $T_A =$	= 25 °C, unless oth	nerwise noted				
Parameter		Symbol	5 Sec	Steady State	Unit	
Drain-Source Voltage		V_{DS}	- 20		V	
Gate-Source Voltage		V_{GS}	± 12			
Continuous Drain Current (T _{.1} = 150 °C)	T _A = 25 °C	- I _D	± 1.5	± 1.4	Α	
Continuous Diam Current (1) = 150°C)	T _A = 85 °C		± 1.2	± 1.0		
Pulsed Drain Current		I _{DM}	± 5		A	
Continuous Diode Current (Diode Conduction) ^a		I _S	- 0.8	- 0.8		
Maximum Power Dissipation ^a	T _A = 25 °C	P _D	0.625	0.568	W	
	T _A = 85 °C		0.400	0.295		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150		°C	

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient ^a	t≤5 sec	R_{thJA}	165	200	
	Steady State		180	220	°C/W
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	105	130	

Notes:

a. Surface mounted on 1" x 1" FR4 board.

^{*} Pb containing terminations are not RoHS compliant, exemptions may apply.

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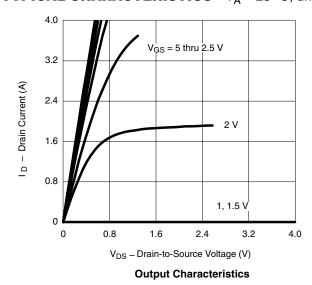
Parameter	Symbol	Test Condition	Min	Тур	Max	Unit	
Static				•			
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	- 0.6		- 1.5	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 12 \text{ V}$			± 100	nA	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = - 20 V, V _{GS} = 0 V			- 1		
		V _{DS} = - 20 V, V _{GS} = 0 V, T _J = 85 °C			- 5	μΑ	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} = -5 \text{ V}, V_{GS} = -4.5 \text{ V}$	- 2			Α	
Drain-Source On-State Resistance ^a		V _{GS} = - 4.5 V, I _D = - 1.5 A		0.145	0.180	Ω	
	r _{DS(on)}	V _{GS} = - 3.6 V, I _D = - 1.4 A		0.165	0.200		
		$V_{GS} = -2.5 \text{ V}, I_D = -0.8 \text{ A}$		0.220	0.265		
Forward Transconductance ^a	9 _{fs}	V _{GS} = - 10 V, I _D = - 1.5 A		3.8		S	
Diode Forward Voltage ^a	V _{SD}	I _S = - 0.8, V _{GS} = 0 V		- 0.78	- 1.1	V	
Dynamic ^b				•			
Total Gate Charge	Qg			3.7	4.5		
Gate-Source Charge	Q _{gs}	$V_{DS} = -10 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -1.5 \text{ A}$		0.9		nC	
Gate-Drain Charge	Q _{gd}			0.9			
Turn-On Delay Time	t _{d(on)}			8	12		
Rise Time	t _r	$V_{DD} = -10 \text{ V}, R_L = 10 \Omega$		25	40		
Turn-Off DelayTime	t _{d(off)}	$I_D \cong -1 \text{ A}, V_{GEN} = -4.5 \text{ V}, R_G = 6 \Omega$		21	32	ns	
Fall Time	t _f	1		20	30		
Source-Drain Reverse Recovery Time	t _{rr}	I _F = - 0.8 A, di/dt = 100 A/μs		20	40		

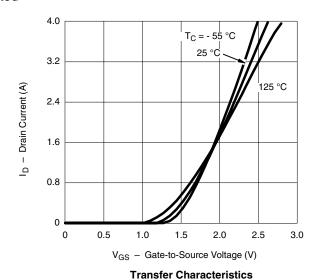
Notes:

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS $T_A = 25 \, ^{\circ}\text{C}$, unless noted

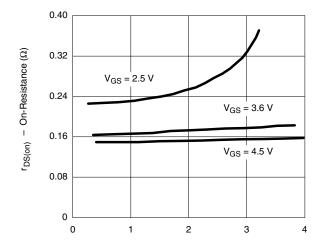






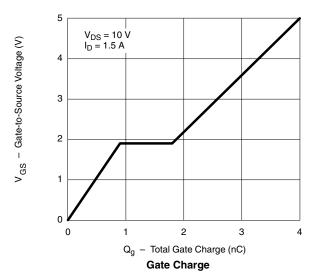
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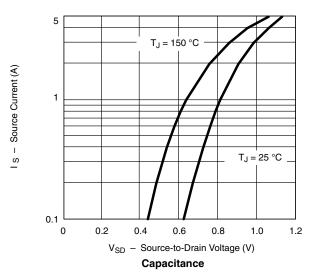
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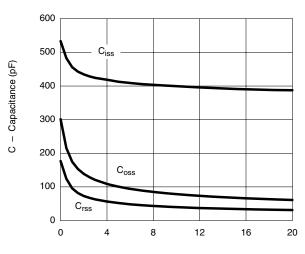


I_D - Drain Current (A)

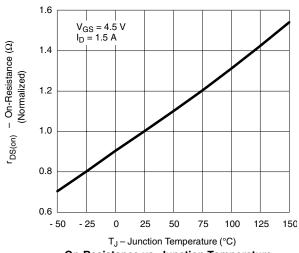
On-Resistance vs. Drain Current



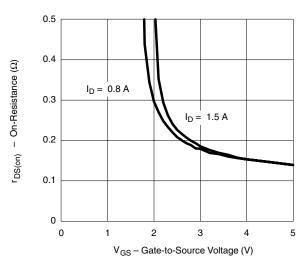




V_{DS} - Drain-to-Source Voltage (V) **Capacitance**



On-Resistance vs. Junction Temperature



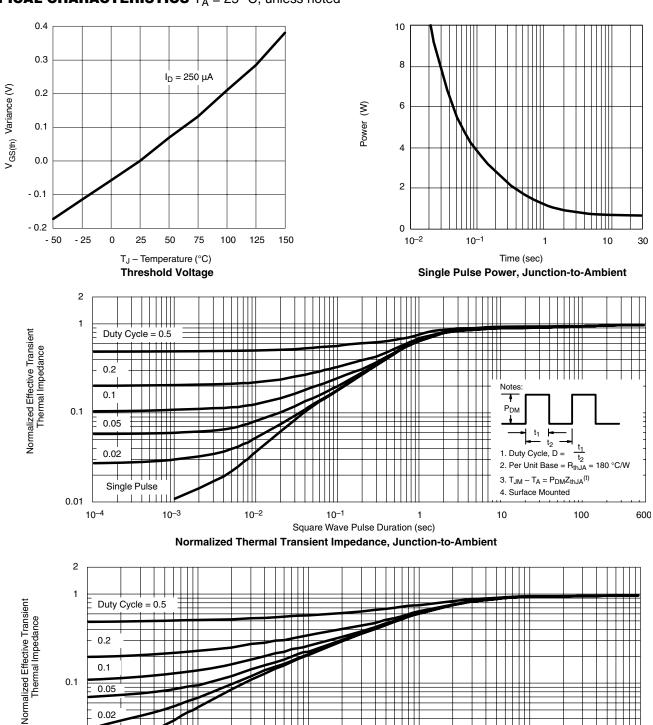
On-Resistance vs. Gate-to-Source Voltage

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10⁻³ 10-2 10^{-1} 1 Square Wave Pulse Duration (sec)

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see http://www.vishay.com/ppg?71072.

Normalized Thermal Transient Impedance, Junction-to-Foot

0.1

0.05 0.02

Single Pulse

0.1

0.01

 10^{-4}

10



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